

F2804S-7P-VB Datasheet N-Channel 40 V (D-S) 175 °C MOSFET

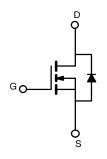
PRODUCT SUMMARY				
V _{DS} (V)	40			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.00084			
I _D (A)	350			
Configuration	Single			
Package	TO-263-7L			

FEATURES

- Trench power MOSFET
- Package with low thermal resistance
- \bullet 100 % R_g and UIS tested







N-Channel MOSFET

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	40	V
Gate-source voltage		V _{GS}	± 20	V
Continuous drain current	T _C = 25 °C	I _D	350	
	T _C = 125 °C		200 ^a	
Continuous source current (diode conduction) ^a		Is	200	А
Pulsed drain current ^b		I _{DM}	1050	
Single pulse avalanche current	1 0.1 ml l	I _{AS}	100	
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	500	mJ
Maximum power dissipation ^b	T _C = 25 °C	D	375	W
	T _C = 125 °C	P_{D}	125	V V
Operating junction and storage temperature	erange	T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient PC	CB mount c	R_{thJA}	40	°C/W
Junction-to-case (drain)		R_{thJC}	0.4	C/VV

Notes

- a. Package limited
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)

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PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40	-	-	V	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		2.5	3.0	3.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1		
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 125 °C	-	-	50	μA	
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 175 °C	-	-	300	μΑ	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 \text{ V}$	100	-	-	Α	
Drain-source on-state resistance ^a	, ,	V _{GS} = 10 V	I _D = 35 A	-	0.00084	=	Ω	
	R _{DS(on)}	V _{GS} = 10 V	I _D = 35 A, T _J = 125 °C	-	-	-		
	, ,	V _{GS} = 10 V	I _D = 35 A, T _J = 175 °C	-	-	-		
Forward transconductance b	9 _{fs}	V _{DS} = 15 V, I _D = 30 A		-	196	-	S	
Dynamic ^b								
Input capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = 25 V, f = 1 MHz	-	11 938	15 525	pF	
Output capacitance	C _{oss}			-	11 163	14 520		
Reverse transfer capacitance	C _{rss}			-	282	370		
Total gate charge ^c	Qg		V _{DS} = 20 V, I _D = 100 A	-	158	250	nC	
Gate-source charge c	Q_{gs}	V _{GS} = 10 V		-	44	-		
Gate-drain charge ^c	Q_{gd}			-	22	-	1	
Gate resistance	R_g	f = 1 MHz		2.70	5.44	8.20	Ω	
Turn-on delay time ^c	t _{d(on)}	V_{DD} = 20 V, R_L = 0.2 Ω I_D \cong 100 A, V_{GEN} = 10 V, R_g = 1 Ω		-	16	25	- - ns	
Rise time ^c	t _r			1	10	17		
Turn-off delay time ^c	t _{d(off)}			-	103	160		
Fall time ^c	t _f			-	61	95		
Source-Drain Diode Ratings and Chara	cteristics ^b							
Pulsed current ^a	I _{SM}			-	-	260	Α	
Forward voltage	V_{SD}	I _F = 60 A, V _{GS} = 0 V		-	0.81	1.5	V	
Body diode reverse recovery time	t _{rr}	I _F = 30 A, di/dt = 100 A/μs		-	165	350	ns	
Body diode reverse recovery charge	Q _{rr}			-	530	1100	nC	
Reverse recovery fall time	t _a			-	66	-	ns	
Reverse recovery rise time	t _b			-	99	-		
Body diode peak reverse recovery current	I _{RM(REC)}			-	-6.2	-	Α	

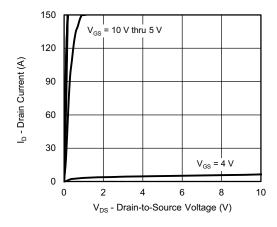
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

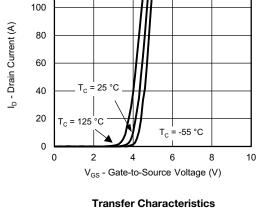
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



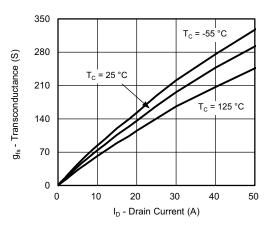
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



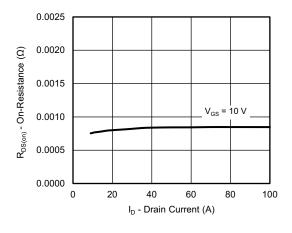
Output Characteristics



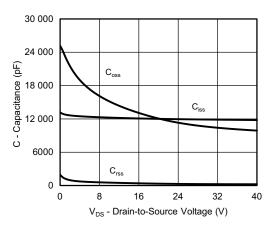
120



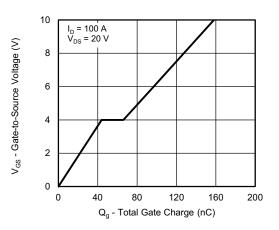
Transconductance



On-Resistance vs. Drain Current



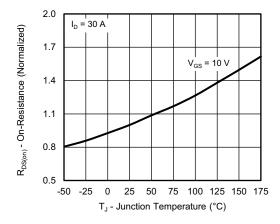
Capacitance



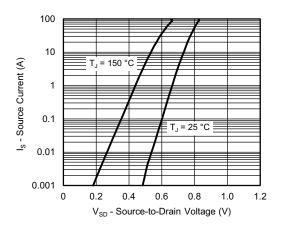
Gate Charge



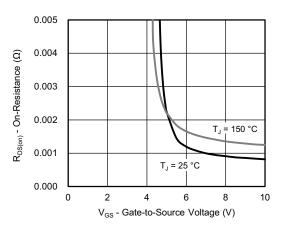
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



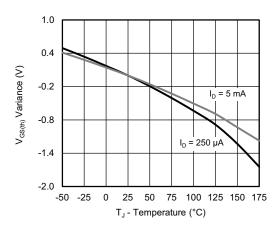
On-Resistance vs. Junction Temperature



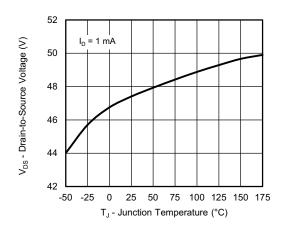
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



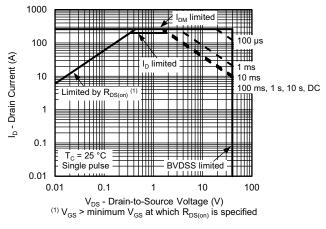
Threshold Voltage



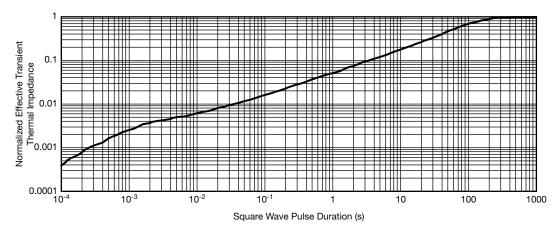
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



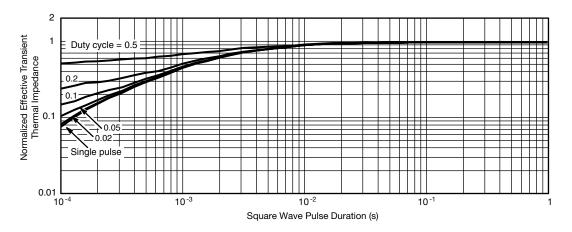
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions



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